Demonstration System EPC9130 Quick Start Guide

48 V to 12 V 5-Phase Regulated IBC Using EPC2045

Revision 1.0



DESCRIPTION

The EPC9130 development board is a 500 kHz switching frequency, 48 V nominal input voltage, 60 A maximum output current, 5-phase intermediate bus converter (IBC) with onboard microcontroller and gate drives, featuring the 100 V EPC2045 enhancement mode (eGaN®) field effect transistor (FET). The purpose of this development board is to provide a regulated 12 V power supply for high performance applications showcasing the superior performance of the EPC2045 eGaN® FET.

The EPC9130 development board has five phases of two EPC2045 eGaN FETs in a half bridge configuration using a uPI semiconductor up1966A gate driver with supply and bypass capacitors. The PWM signals to the gate drivers are fed by an onboard dsPIC33 microcontroller from Microchip®. The output voltage is regulated to 12 V. The board contains all critical components and layout for optimal switching performance. There are also various probe points to facilitate simple waveform measurement and efficiency calculation.

A complete block diagram of the circuit is given in Figure 1. The converter uses five interleaved half-bridges built from EPC2045 as power switches, and the uPI1966A as the gate driver. Basic voltage mode control of output is done with the microcontroller. Current sharing among the phases, under-voltage lockout as well as overcurrent, over-voltage, and overtemperature protection is available. To allow more flexible operation for this evaluation board, only current sharing and under-voltage lockout are implemented for this EPC9130 demo board.

OUICK START PROCEDURE

Development board EPC9130 is easy to set up to evaluate the performance of the EPC2045 eGaN FET and uPI1966A driver, as well as the transient response due to the dsPIC33 microcontroller. Refer to Figures 2 and 3 for proper connect and measurement setup and follow the procedure below:

- 1. With power off, connect the input power supply bus to $+V_{\rm IN}$ banana sockets (red) and ground / return to -V_{IN} banana sockets (black) as shown.
- 2. With power off, connect a/multiple DC load(s) to the output $+V_{OUT}$ (red) and -V_{OLIT} (black) return to your circuit as required.
- 3. With power off, connect the gate drive and controller input supply to $+V_{DD}$ (red) and ground return to $-V_{DD}$ (black).
- 4. Turn on the gate drive supply make sure the supply is within the 7.5 V and 12 V range.
- 5. Turn on the bus voltage to the required value (do not exceed the absolute maximum voltage of 60 V on V_{IN}) and probe switching node to observe switching operation.
- 6. Once operational, turn on the load current and adjust the bus voltage within the operating range and observe the output switching behavior, efficiency, and other parameters.
- 7. For shutdown, please follow steps in reverse.

NOTE. When measuring the high frequency content switch node, care must be taken to avoid long ground leads. Measure the switch node by using a probe jig with the oscilloscope probe tip. Refer to figure 3 for proper scope probe technique.



EPC9130 Top View

For more information on the EPC2045 eGaN FETs please refer to the datasheet available from EPC at www.epc-co.com. The datasheets should be read in conjunction with this guick start guide.

Table 1: Performance Summary ($T_A = 25$ °C) EPC9130

| Symbol | Parameter | Min | Тур | Max | Units |
|------------------|--|-----|-----|-----|-------|
| V _{DD} | Gate Drive and Controller Input Supply | | 10 | 12 | ٧ |
| V _{IN} | Bus Input Voltage | | 48 | 60 | ٧ |
| V _{OUT} | Output Voltage | | 12 | | V |
| l _{out} | Output Current | | 50* | | Α |
| f _{sw} | f _{sw} Switching Frequency | | 500 | | kHz |

 $^{^{\!} k}$ Maximum output current depends on die temperature – actual maximum current with be subject to bus voltage, ambient temperature, and thermal design considerations, i.e. air flow and heat sinking.

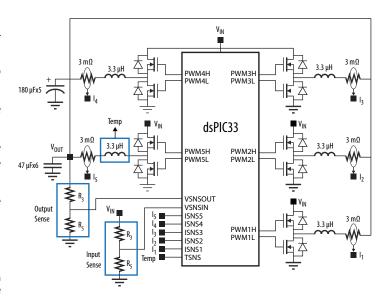


Figure 1. Block Diagram of EPC9130 Development Board.

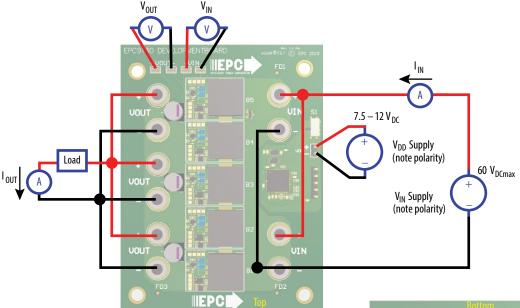


Figure 2: Proper Connection and Measurement Setup for efficiency/transient characterization (Top)

CIRCUIT PERFORMANCE

The EPC9130 demonstration circuit was designed to showcase the size and performance that can readily achieved using eGaN FETs. Figure 4 shows typical full-load waveforms under 400 LFM (2 m/s) for a 48 V input voltage, unless otherwise noted, using probe tip adapters as shown in Figure 3. Figure 5 shows efficiency plots for 48 V input voltage at 25°C.

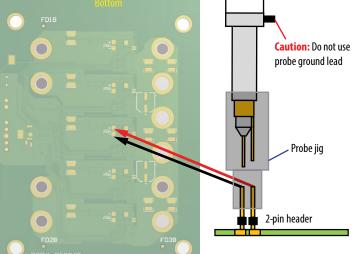


Figure 3: Optional Switch Node Measurement (Bottom)

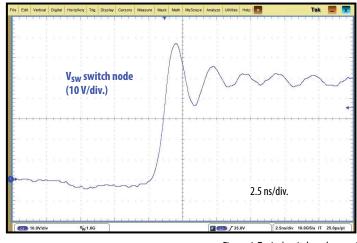




Figure 4: Typical switch node waveforms taken at 48 V_{IN} to 12 $V_{OUT}/50~A_{OUT}$

OPERATING CONSIDERATIONS

The EPC9130 is a demonstration platform intended to show the capabilities of eGaN FETs in a multiphase IBC application. The transient response has been optimized for a 25 A transient with a slew rate of 1 A/µs and voltage overshoot/undershoot of ~1 V. See figure 6.

Source and Load

It is recommended that the converter be driven from a source with both low dc and ac impedance. Additional input capacitance may be added as necessary.

Thermal Management

The EPC9130 demo board has no on-board thermal protection. Thermal images for steady state full-load operation are shown in Figure 7. The EPC9130 is intended for bench evaluation with nominal room ambient temperature and forced air cooling. Operation without forced air cooling is possible for limited power operation. It is recommended that the maximum temperature on the EPC9130 not exceed 125°C.

Electrical Protection

The EPC9130 has under-voltage lockout and will not operate below input voltage of 16 V. For flexible operation of this evaluation board, designed features such as over-current, over-temperature, and over-voltage protection were not enabled, so the user is encouraged to operate in the ranges specified on Table I.

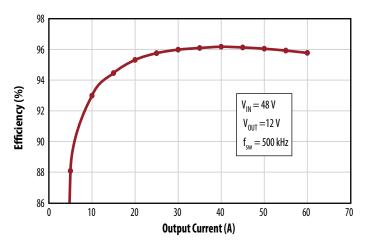


Figure 5: Typical efficiency curve. 48 V to 12 V.

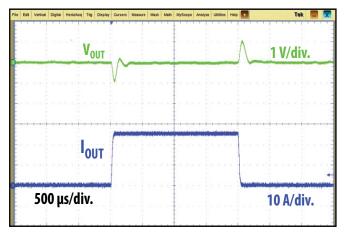


Figure 6: Typical load transient-12.5 A to 37.5 A to 12.5 A over a period of 2 ms

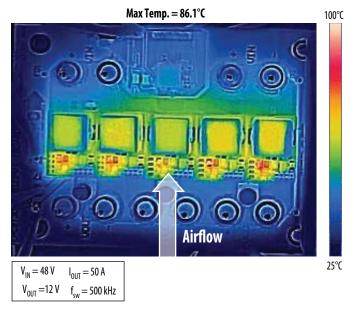


Figure 7: Thermal image of EPC9130. Operating Conditions: 400 LFM (2 m/s) forced convection, ambient temperature 25°C, thermal steady state.

Table 2: Bill of Materials

| Item | Qty | Reference | Part Description | Manufacturer | Part# |
|------|-------------|---|---|----------------------|------------------------|
| 1 | 4 per phase | CINA, CINB, CINC, CIND | Capacitor, 1 μF, 20%, 100 V, X7S, 0805 | TDK | C2012X7S2A105M125AB |
| 2 | 2 per phase | Q1, Q2 | 100 V 5.6 mΩ eGaN FET | EPC | EPC2045 |
| 3 | 1 per phase | CB1 | Capacitor, 0.1 μF, 10%, 25 V, X5R, 0402 | TDK | C1005X5R1E104K050BC |
| 4 | 1 per phase | CDEC1 | Capacitor, 1 µF, 10%, 25 V, X5R, 0402 | TDK | C1005X5R1E105K050BC |
| 5 | 1 per phase | U4 | UPI, UP1966A, USMD, BGA | UPI | UP1966A |
| 6 | 4 per phase | COUT1, COUT2, COUT3, COUT4 | Capacitor, 22 μF, 20% 25 V, X5R, 0805 | TDK | C2012X5R1E226M125AC |
| 7 | 1 per phase | L3B | Fixed Inductor, 3.3 uH, 15 A, 9.2 mΩ | Vishay | IHLP5050EZER3R3M01 |
| 8 | 1 per phase | RVDD | Resistor, 4.7 Ω, 1% ,1/16 W, 0402 | Stackpole | RMCF0402FT4R70 |
| 9 | 1 per phase | R9 | Resistor, 10 kΩ, 1% ,1/16 W, 0402 | Stackpole | RMCF0402FT10K0 |
| 10 | 1 per phase | R10 | Resistor, 10 kΩ, 1% ,1/16 W, 0402 | Stackpole | RMCF0402FT10K0 |
| 11 | 1 per phase | CL | Capacitor, 22 pF, 1%, 50 V, C0G/NP0, 0402 | Kemet | CBR04C220F5GAC |
| 12 | 1 per phase | СН | Capacitor, 22 pF, 1%, 50 V, C0G/NP0, 0402 | Kemet | CBR04C220F5GAC |
| 13 | 1 per phase | R11 | Resistor, 750 Ω, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT750R |
| 14 | 1 per phase | C18 | Capacitor, 220 pF, 10%, 50 V, X7R, 0402 | Kemet | C0402C221K5RACTU |
| 15 | 1 per phase | R6 | Resistor, 3 mΩ, 1%, 1 W, 1206 | Stackpole | CSNL1206FT3L00 |
| 16 | 1 per phase | R7 | Resistor, 10 Ω, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT10R0 |
| 17 | 1 per phase | R8 | Resistor, 10 Ω, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT10R0 |
| 18 | 4 | E1, E2, E3, E4 | Test Point, SMT | Keystone Electronics | Keystone Elect, 5015 |
| 19 | 1 per phase | U5 | IC OpAmp Current Sense 100 kHz, 6DFN | Linear Technology | LT6105 |
| 20 | 10 | B1, B2, B3, B4, B5, B6, B7, B8, B9, B10 | Jack, Non-Insulated, .218" | Stackpole | Keystone Elect, 575-4 |
| 21 | 1 | R2 | Resistor, 4.99 kΩ, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT4K99 |
| 22 | 1 | R4 | Resistor, 1 kΩ, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT1K00 |
| 23 | 1 | C16 | Capacitor, 220 pF, 10%, 50 V, X7R, 0402 | Kemet | C0402C221K5RACTU |
| 24 | 1 | R3 | Resistor, 30 kΩ, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT30K0 |
| 25 | 1 | R5 | Resistor, 1 kΩ, 1%, 1/16 W, 0402 | Stackpole | RMCF0402FT1K00 |
| 26 | 1 | C17 | Capacitor, 220 pF, 10%, 50 V, X7R, 0402 | Kemet | C0402C221K5RACTU |
| 27 | 5 | CS1, CS2, CS3, CS4, CS5 | Capacitor, 220 pF, 10%, 50 V, X7R, 0402 | Kemet | C0402C221K5RACTU |
| 28 | 1 | L1 | Ferrite Bead, 180 Ω, 0603, 1LN | Murata | BLM18PG181SN1D |
| 29 | 1 | L2 | Ferrite Bead, 180 Ω, 0603, 1LN | Murata | BLM18PG181SN1D |
| 30 | 5 | C1, C2, C3, C4, C5 | Capacitor, 10 μF, 6.3 V, X6S, 0603 | Taiyo Yuden | JMK107BC6106MA-T |
| 31 | 1 | U6 | Temp Sensor, Analog Voltage, SOT 23-3 | Microchip | TC1047AVNBTR |
| 32 | 1 | C26 | Capacitor, 220 pF, 10%, 50 V, X7R, 0402 | Kemet | C0402C221K5RACTU |
| 33 | 1 | S1 | Sliding Switch, SPDT, 300 mA, 4 V | APEM | MA12RTR |
| 34 | 1 | R1 | Resistor, 0 Ω, 1%, 1/8 W, 0603 | Panasonic | ERJ-3GEY0R00V |
| 35 | 3 | C6, C7, C8 | Capacitor, 1 μF, 10%, 25 V, X5R, 0603 | Murata | GRM188R61E105KA12D |
| 36 | 1 | U1 | IC Regulator, LDO, 5 V, 0.25 A, 8DFN | Microchip | MCP1703T-5002E/MC |
| 37 | 1 | U2 | IC Regulator, LDO, 3.3 V, 0.25 A, 8DFN | Microchip | MCP1703T-3302E/MC |
| 38 | 1 | U3 | Microcontroller, dsPIC33, 44-pin QFN | Microchip | DSPIC33EP128GS704-E/ML |
| 39 | 1 | J1 | 2 pins of Tyco, 4-103185-0 | Тусо | 4-103185-0 |
| 40 | 1 | J4 | 5 pins of Tyco, 4-103185-0 | Тусо | 4-103185-0 |
| 41 | 3 | CBULK1, CBULK2, CBULK3 | Aluminium Capacitor, 180 μF, 16 V, 20%, OSCON | Panasonic | 16SVPF180M |
| 42 | 1 | RMCLR | Resistor, 10 kΩ, 1%, 1/10 W, 0603 | Stackpole | RMCF0603FT10K0 |

Table 3: Optional Components

| Item | Qty | Reference | Part Description | Manufacturer | Part# |
|------|-------------|------------------------------|---|--------------|----------------------|
| 1 | 1 per phase | Q3 | 100 V 5.6 mΩ eGaN FET | EPC | EPC2045 |
| 2 | 6 | C19, C20, C21, C22, C23, C24 | Capacitor, 47 μF, 20%, 25 V, X5R, 1210 | TDK | TMK325ABJ476MM-P |
| 3 | 1 per phase | CINE | Capacitor, 4.7 μF, 10%, 100 V, X7S, 1210 | TDK | CGA6M3X7S2A475K200AB |
| 4 | 2 | CBULK4, CBULK5 | Aluminium Capacitor, 180 μF, 16 V, 20%, OSCON | Panasonic | 16SVPF180M |

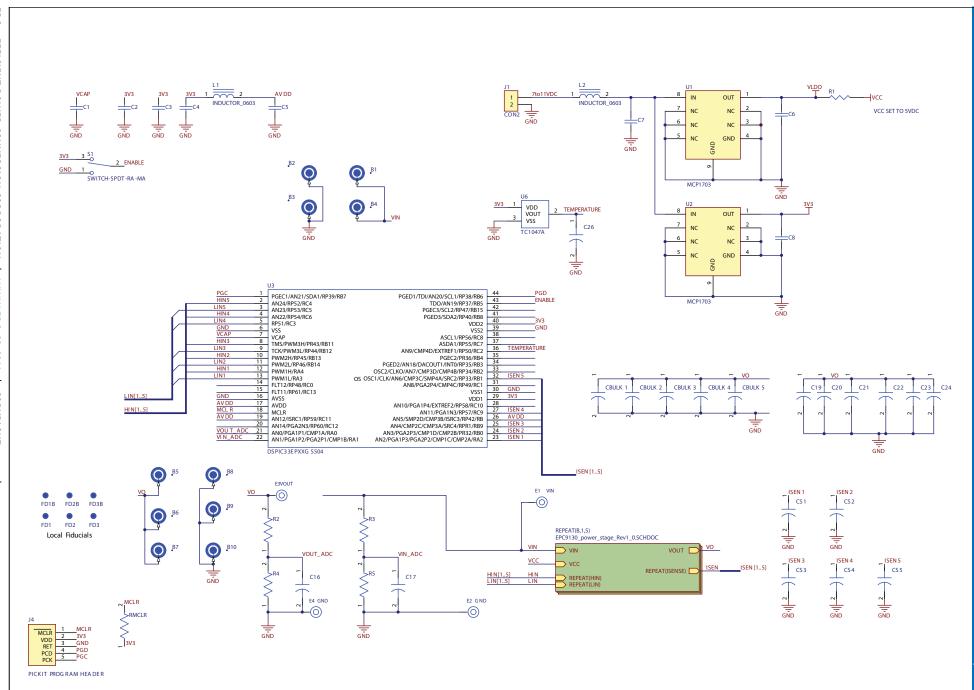


Figure 8: EPC9130 Controller schematic

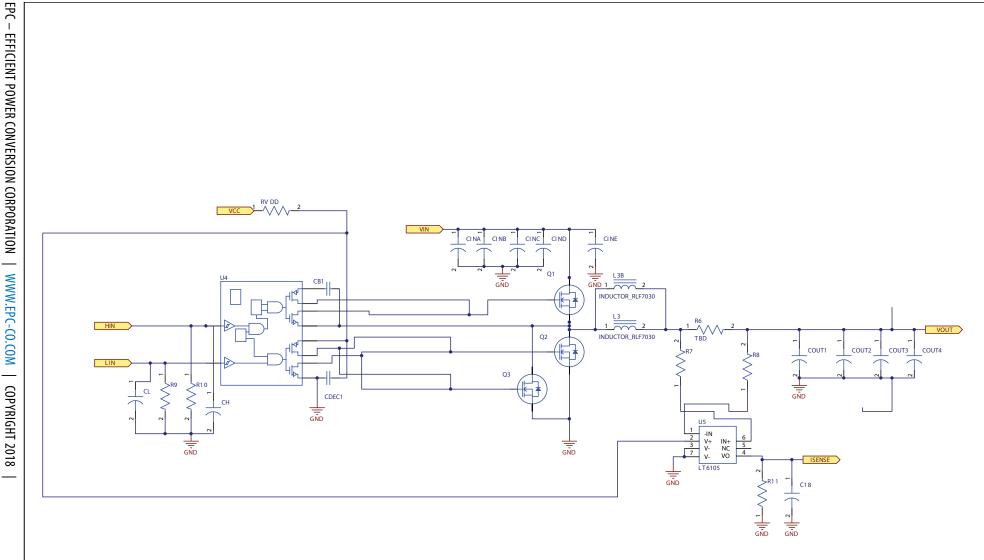


Figure 9: EPC9130 Power Stage schematic

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